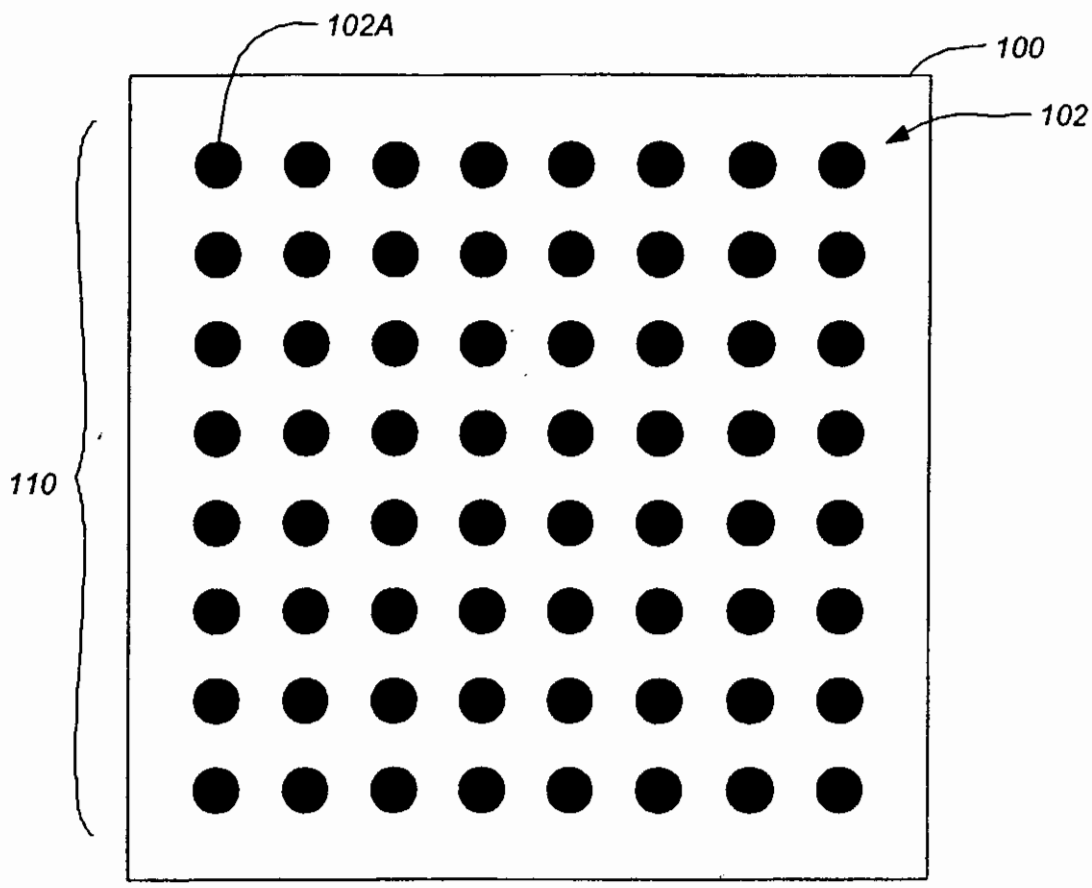


FIG. 1A

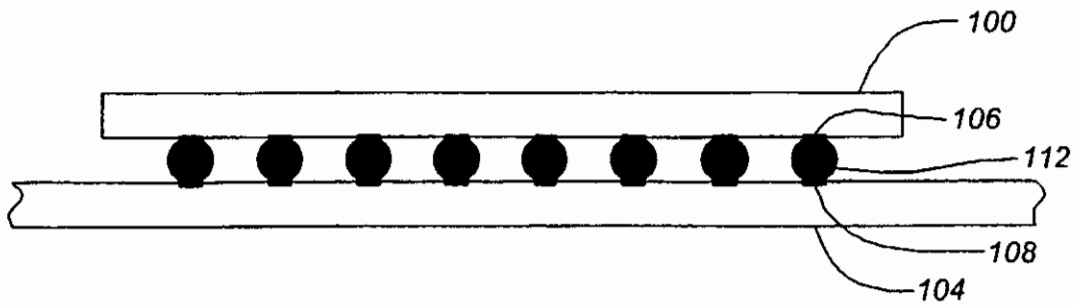


FIG. 1B

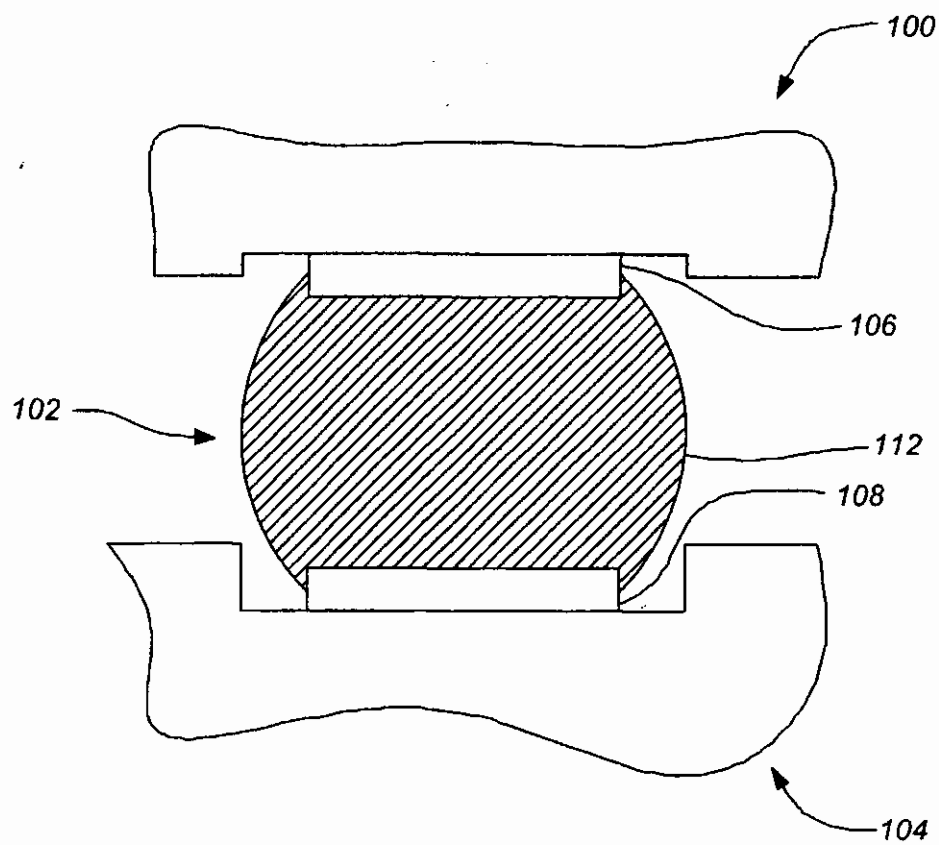


FIG. 2

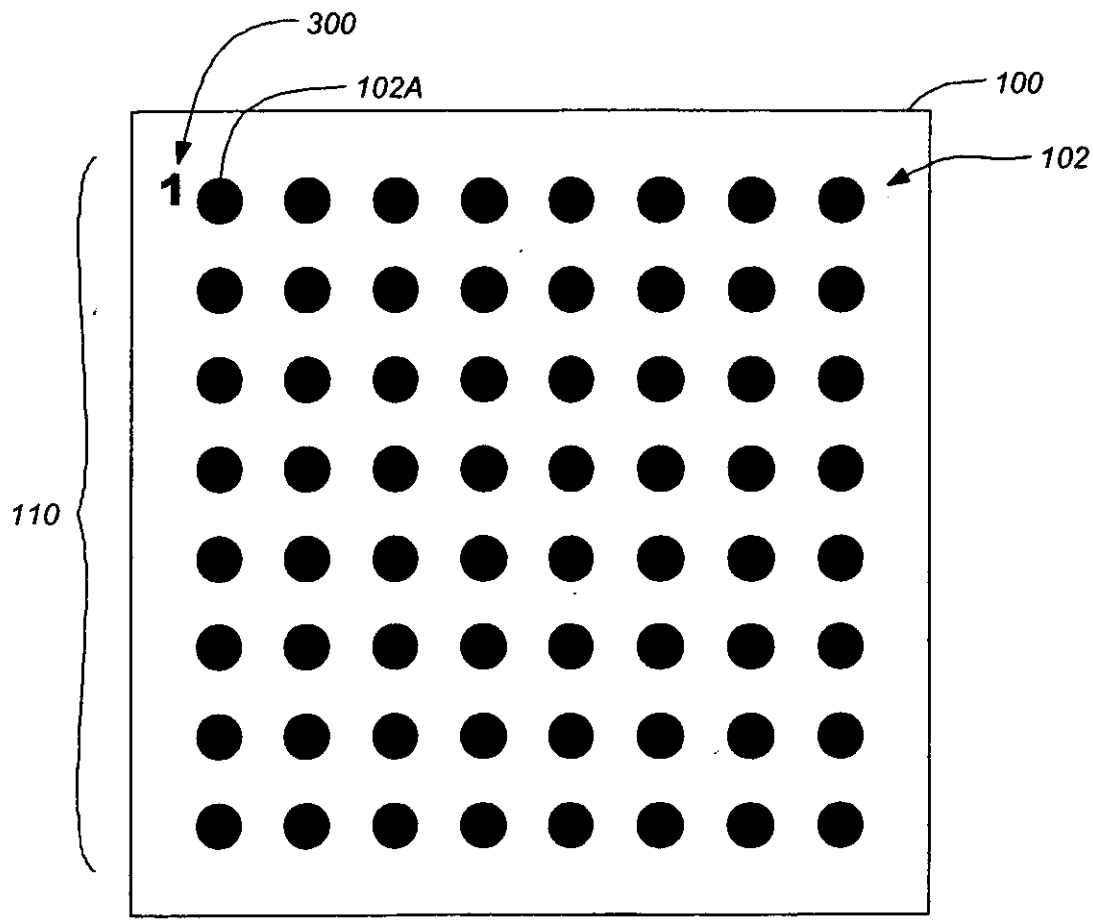


FIG. 3

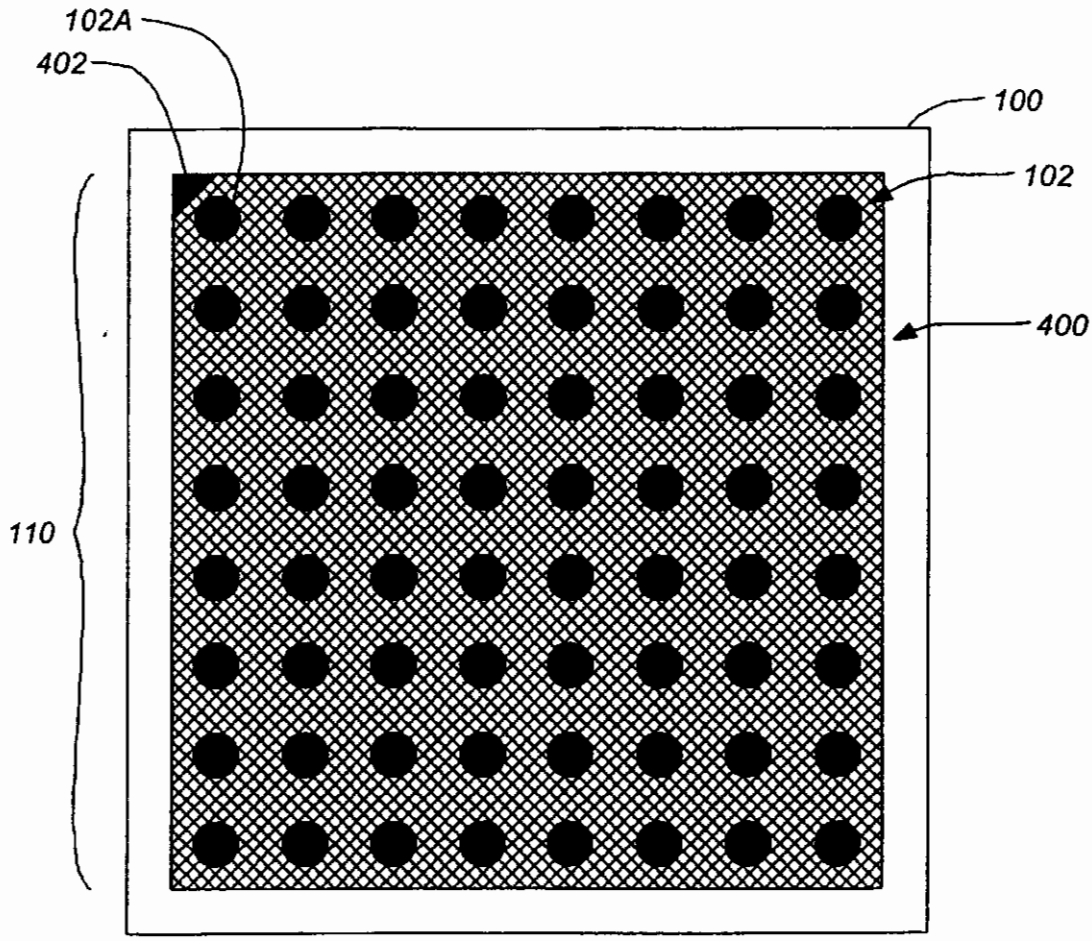


FIG. 4

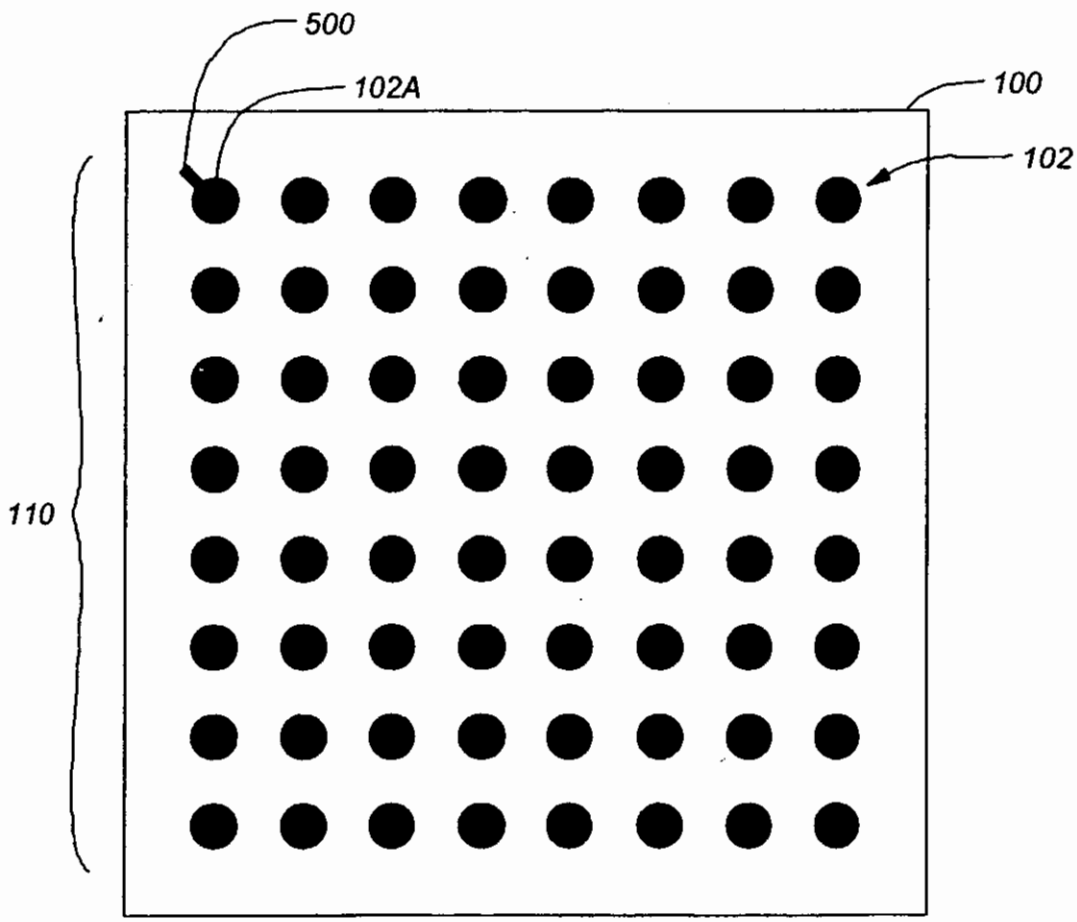


FIG. 5

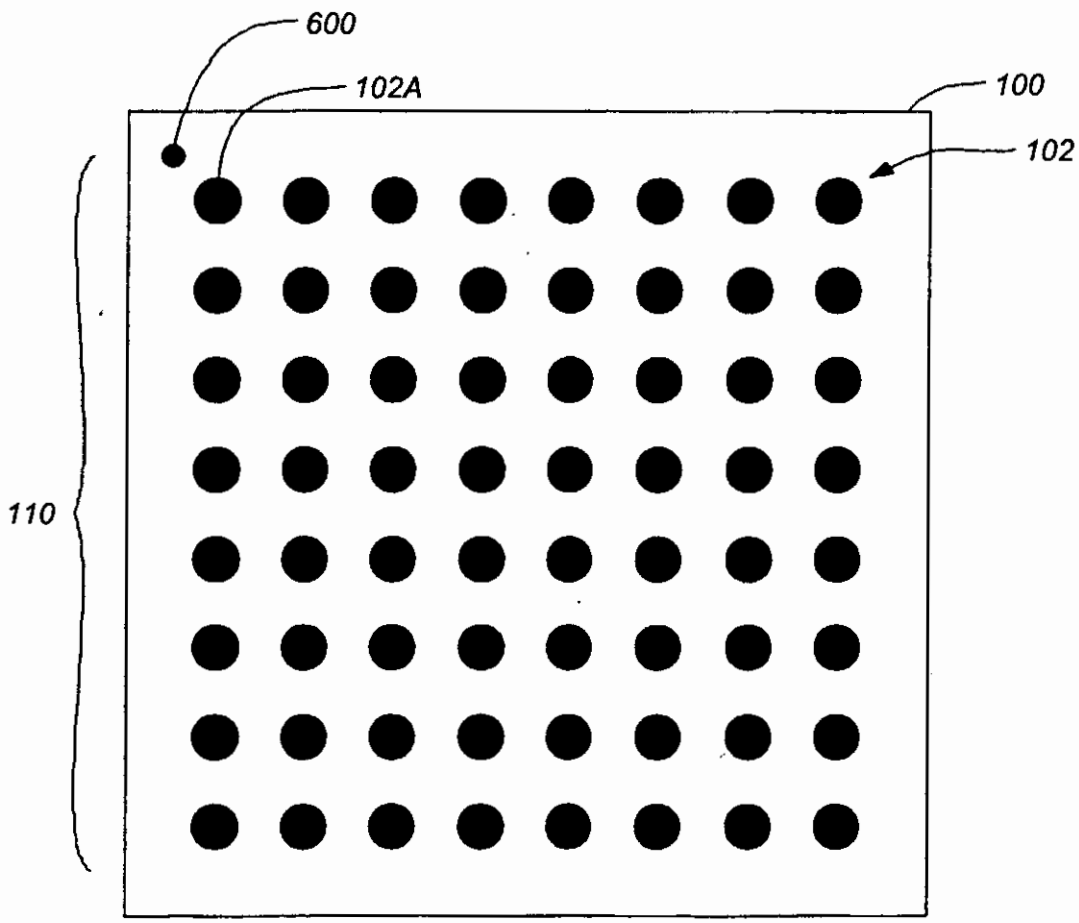


FIG. 6

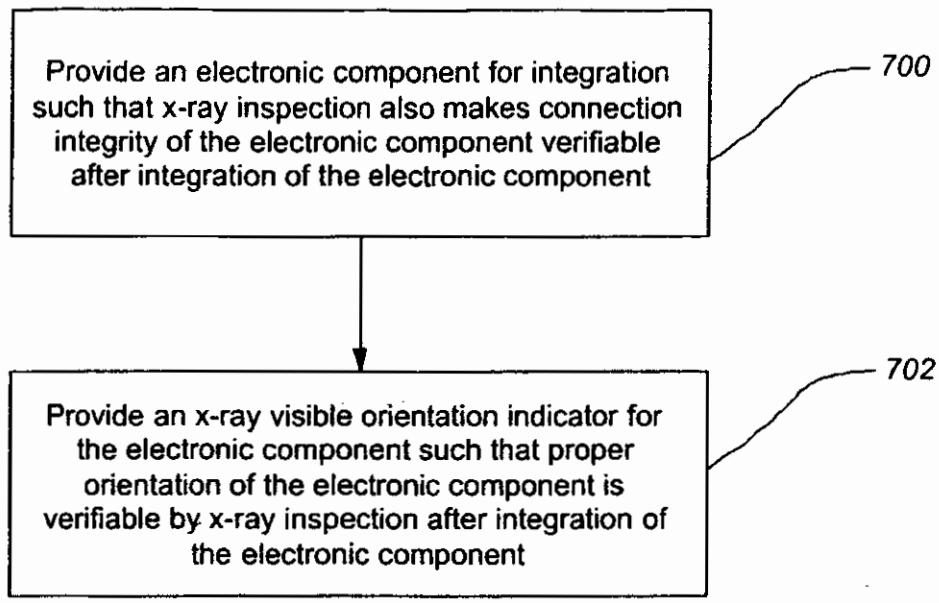

Provide an electronic component for integration such that x-ray inspection also makes connection integrity of the electronic component verifiable after integration of the electronic component
700
Provide an x-ray visible orientation indicator for the electronic component such that proper orientation of the electronic component is verifiable by x-ray inspection after integration of the electronic component
702

FIG. 7

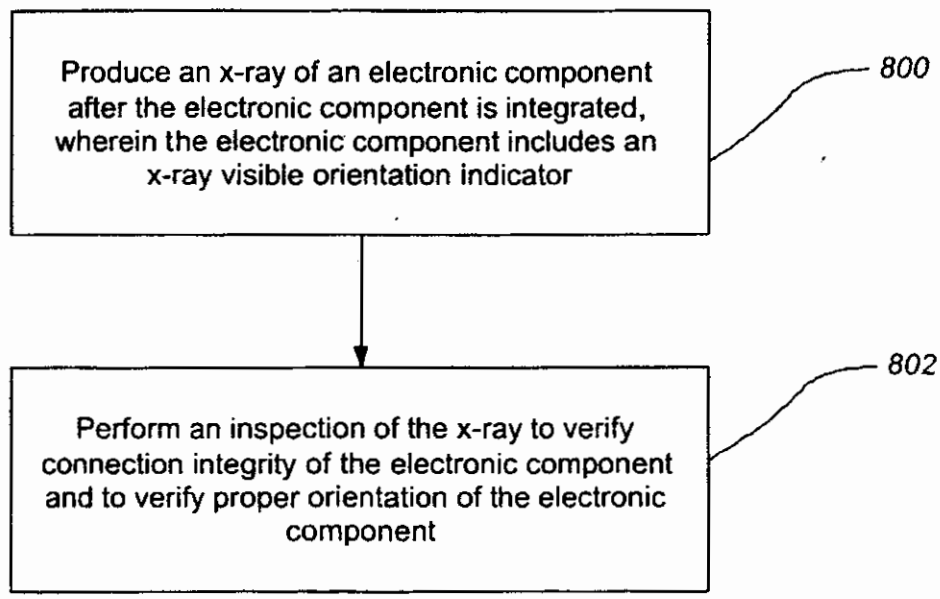

Produce an x-ray of an electronic component after the electronic component is integrated, wherein the electronic component includes an x-ray visible orientation indicator
800
Perform an inspection of the x-ray to verify connection integrity of the electronic component and to verify proper orientation of the electronic component
802

FIG. 8